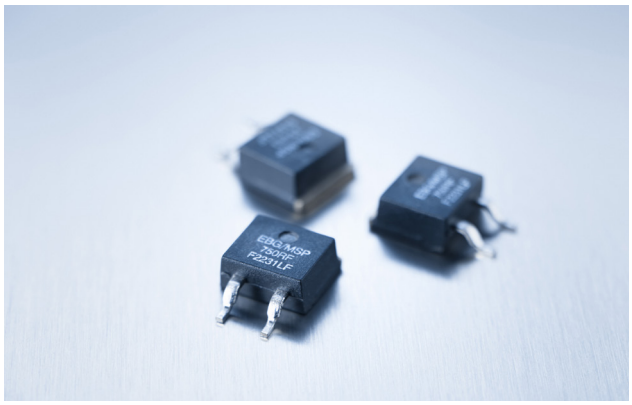
Series MSP 35 SMD TO-220

(MHP 35 for high temperature soldering)

35 W Thick Film Resistor for surface mount including Metal Tab

35 W Film Power Resistor for surface mount including metal tab.

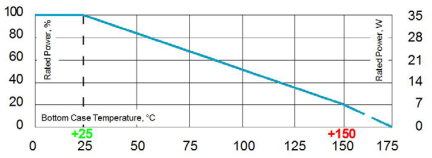


Features

- 35 W operating power
- **SMD TO-220 package** configuration
- Molded case for environmental protection
- Resistor element is electrically insulated from the metal sink tab
- Non-Inductive design
- ROHS compliant
- Materials in accordance with UL 94 V-0
- High soldering version available

Technical Specifications

Resistance value	0.1 Ω to 1 MΩ (other values on special request)
Resistance tolerance	±1 % to ± 10 % ±0.5 % on special request for limited ohmic values
Temperature coefficient	< 3 Ω: ask for details ≥ 3 Ω to 10 Ω: ±100 ppm + 0.002 Ω/°C ≥ 10 Ω: ±50 ppm/°C (referenced to 25 °C, ΔR taken at +85°C)
Power rating	35 W at 25°C bottom case temperature
Maximum operating voltage	350 V
Dielectric strength voltage	1800 V AC
Insulation resistance	> 10 GΩ at 1000 V DC
Momentary overload	2x rated power with applied voltage not to exceed 1.5x maximum continuous operating voltage for 5 s. ΔR ±(0.3 % + 0.01 Ω) max.
Load life	MIL-R-39009, 2000 h at rated power, ΔR ±(1.0 % + 0.01 Ω) max.
Moisture resistance	MIL-STD-202, method 106 ΔR = (0.5 % + 0.01 Ω) max.
Thermal shock	MIL-STD-202, method 107, Cond. F, ΔR = (0.3 % + 0.01 Ω) max.
Working temperature range	-55 °C to +175 °C
Terminal strength	MIL-STD-202, method 211, Cond. A (Pull Test) 2.4 N, ΔR = (0.2 % + 0.01 Ω) max.
Vibration, high frequency	MIL-STD-202, method 204, Cond. D, ΔR = (0.2 % + 0.01 Ω) max.
Lead material	nickel-plated copper, dip-tinned
Ground plate material	german silver; alternative material on request
Heat resistance to cooling plate	Rth < 4.28 K/W
Weight	~1,4 g



Derating (thermal resist.) MSP-35:
0.23 W/K (4.28 K/W)

Case temperature must be used for definition of the applied power limit. Case temperature measurement must be done with a thermo-couple contacting the center of the component mounted on the designed heat sink. Thermal grease should be applied properly.

How to make a request

MSP_Ohmic Value_Tolerance

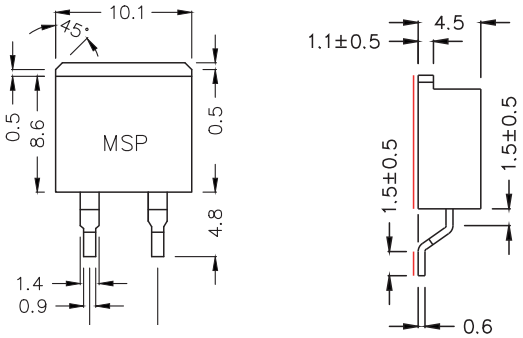
For example:
MSP 39R 5%

Example for higher solder profile:
MHP 560R 1%

Soldering Note:
During surface mount soldering, the soldering temp. profile **must not** cause the metal tab of this device to **exceed 215°C**.

For solder profile temp. above 215°C up to max. 260°C, please use our alternative type MHP 35 SMD TO-220.

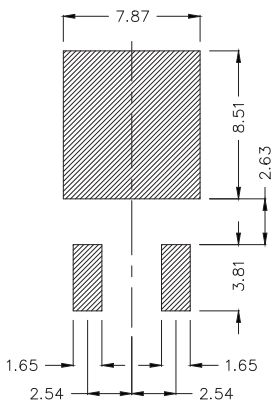
Dimensions in mm



Tolerances ±0.2 unless otherwise noted!
TO-220 style power package for SMD applcations 35 W power rating at 25°C case temerature.

Flatness of ground plate to contacts <0.1mm

Soldering Template



The above spec. sheet features our standard products. For further options please contact your local Miba Resistors representative.

Series MSP 35 SMD TO-220

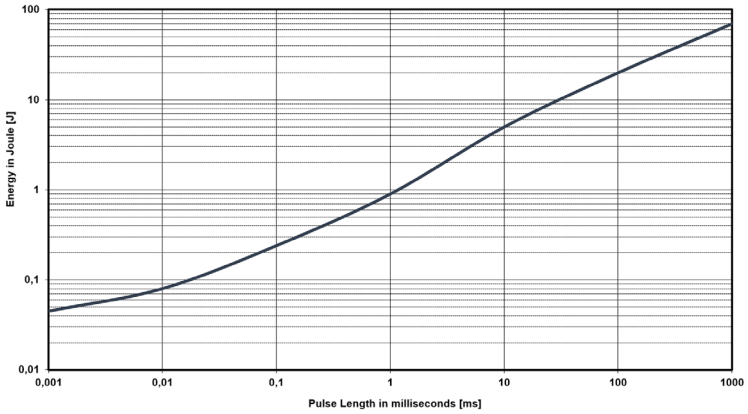
Pulse Energy Curve (typical rating for MSP 35)

Note:These energy values are reference values → depending on ohmic value e.g. 1 Ω to 10 Ω and used resistive paste, a variation in max. energy load capability is possible

Test procedure

Every test resistor was mounted with thermal compound (0.9 W/mK) on a water cooled heatsink

- Constant inlet water temperature: +50°C
- The test time of each tested resistor: 10min.
- Break time between two pulses: 1s.
- To determine good / defect parts the ohmic value was measured before and after tests: a change of tolerance of more than 0.1% means defect



Description of Pulse Energy Curve

- Shape of pulse = e-function
- Time between two pulses = 1 second
- Pulse length = time constant of 1 tau (1 means ... tau = 1ms)

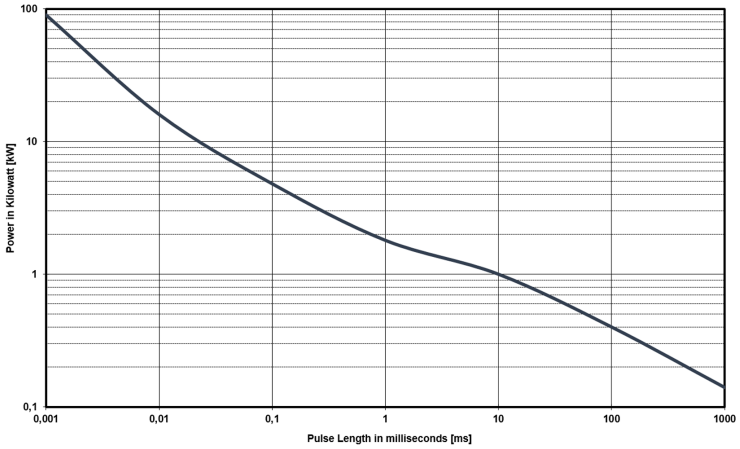
Example

At 1 ms tau the MXP 35 with e.g. 1 Ω to 10 Ω can withstand an energy level of about 0.9 J, when the pulse pause time is ≥ 1s

At a symmetrical frequency > 1 kHz at pulse length ≥ 10 µs. the maximum applied pulse energy for MXP 35 is a result out of the nominal power 35 W divided by the operating frequency (at 25°C bottom case) (E = 35 W / F)

Pulse Power Curve (typical rating for MSP 35)

The power curve shows the max. possible power which can be applied for a certain duration.
Referring to the same test procedure as described above.



Description of Pulse Power Curve

- Shape of pulse = e-function
- Time between two pulses = 1 second
- Pulse length = time constant of 1 tau (1 means ... tau = 1ms)

Example

For the time-constant of 1 ms you can apply about 1.8 kW max. (Pp = 2*E / T)→, if the time between two such peaks is ≥ 1s

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